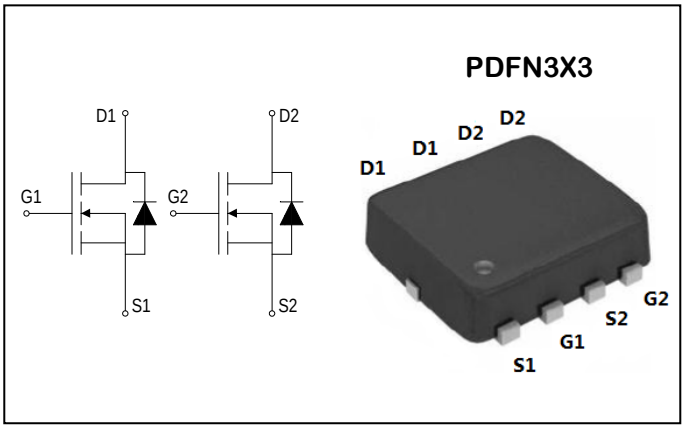
Dual N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY

V_{DSS}	I_D	$R_{DS(ON)}$ (mΩ)
30V	35A	13mΩ



Absolute Maximum Ratings (T_A = 25°C unless otherwise specifed)

Symbol	Parameter		Ratings	Unit
Common Ratings				
V_{DSS}	Drain-Source Voltage		30	V
V_{GSS}	Gate-Source Voltage		±20	
T_J	Maximum Junction Temperature		150	°C
T_{STG}	Storage Temperature Range		-55 to 150	°C
I_S	Diode Continuous Forward Current	T_C=25°C	35	A
Mounted on Large Heat Sink				
I_{DM}	300μs Pulse Drain Current Tested(1)	T_C=25°C	140	A
I_D	Continuous Drain Current	T_C=25°C	35	A
P_D	Maximum Power Dissipation		20	W

1. Pulse width limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	Ratings	Unit
R_{thJC}	Thermal resistance junction-case max	6.2	°C/W
R_{thJA}	Thermal resistance junction-ambient max	45	°C/W

Electrical Characteristics (TA=25°C Unless Otherwise Noted)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
On/off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V, I_{DS}=250uA	30	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}= 30V, V_{GS}=0V T_J=25°C	--	--	1.0	uA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_{DS}=250uA	1.3	1.9	2.4	V
I_{GSS}	Gate Leakage Current	V_{GS}=±20V, V_{DS}=0V	--	--	±100	nA
$R_{DS(ON)}$	Drain-SourceOn-stateResistance(2)	V_{GS}= 10V, I_{DS}=20A	--	10	13	mΩ
		V_{GS}= 4.5V, I_{DS}=10A	--	14	18	
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{GS}=0V,	--	880	--	pF
C_{oss}	Output Capacitance	V_{DS}= 15V,	--	140	--	
C_{rss}	Reverse Transfer Capacitance	Frequency=1.0MHz	--	110	--	
Switching Characteristics						
$t_{d(ON)}$	Turn-on Delay Time(1)	V_{DD}=15V,	--	6	--	ns
t_r	Turn-on Rise Time(1)	I_D= 20A, V_{GS}= 10V,	--	5	--	
$t_{d(OFF)}$	Turn-off Delay Time(1)	R_{GEN}=3Ω	--	25	--	
t_f	Turn-off Fall Time(1)		--	7	--	
Q_g	Total Gate Charge(1)	V_{DS}=15V, V_{GS}= 10V,	--	19	--	nC
Q_{gs}	Gate-Source Charge(1)	I_{DS}=20A	--	4.3	--	
Q_{gd}	Gate-Drain Charge(1)		--	6.5	--	
Avalanche Characteristics						
EAS	Single Pulse Avalanche Energy (3)	L=0.5mH ,V_{GS}=10V,R_g=25Ω, I_{AS}=8A T_J=25°C		16		mJ
Diode Characteristics						
V_{SD}	Diode Forward Voltage(2)	I_{SD} = 20A, V_{GS} = 0 ,T_J=25°C	--	--	1.2	V
t_{rr}	Reverse Recovery Time	I_{SD}=20A, dI_{SD}/dt=100A/μs	--	7	--	ns
q_{rr}	Reverse Recovery Charge		--	6.3	--	nC

NOTES:

1. Surface Mounted on FR4 Board, t ≤ 10 sec.

2.The data tested by pulsed , pulse width ≦ 300us , duty cycle ≦ 2%

3.The Min. value is 100% EAS tested guarantee.

Typical Performance Characteristics

Figure 1: On-Region Characteristics

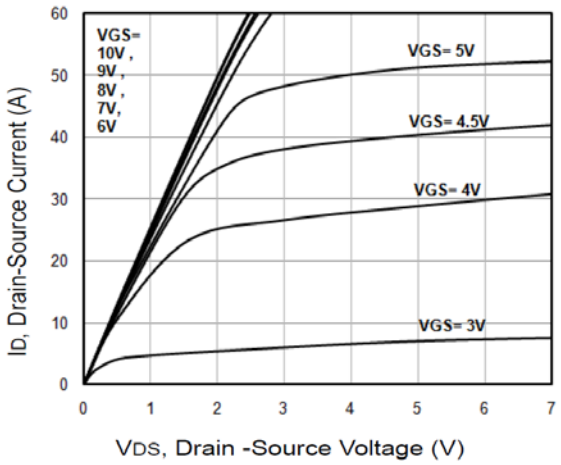


Figure 2: Normalized On-Resistance Vs. Temperature

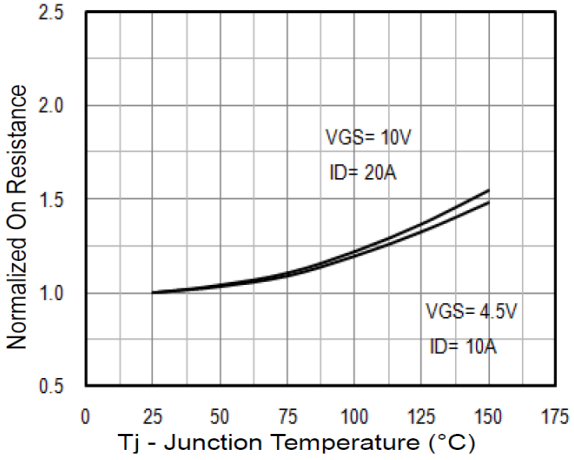


Figure 3: Typical Transfer Characteristics

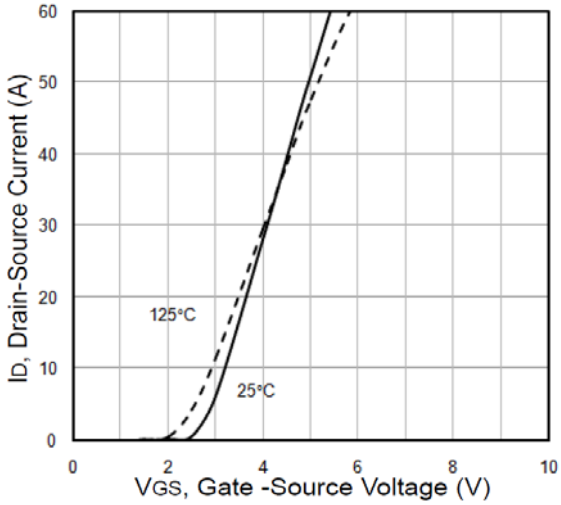


Figure 4: Gate Charge Waveform

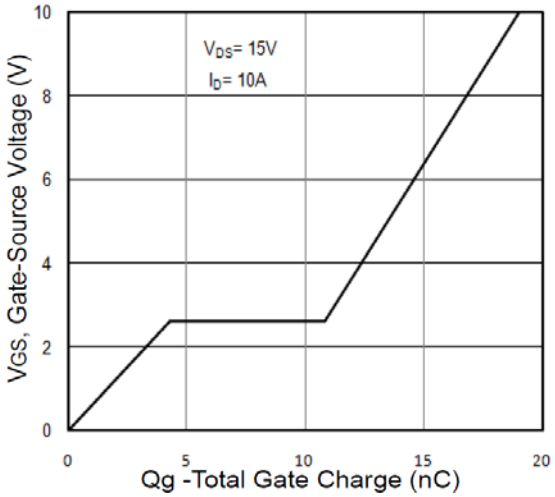


Figure 5: Threshold Voltage Vs. Temperature

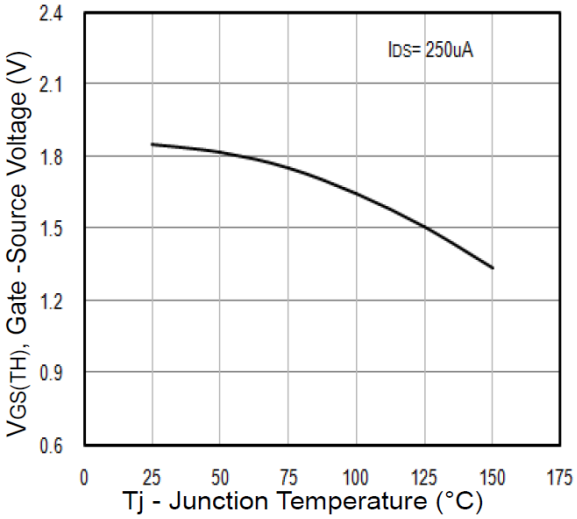


Figure 6: Maximum Safe Operation Area

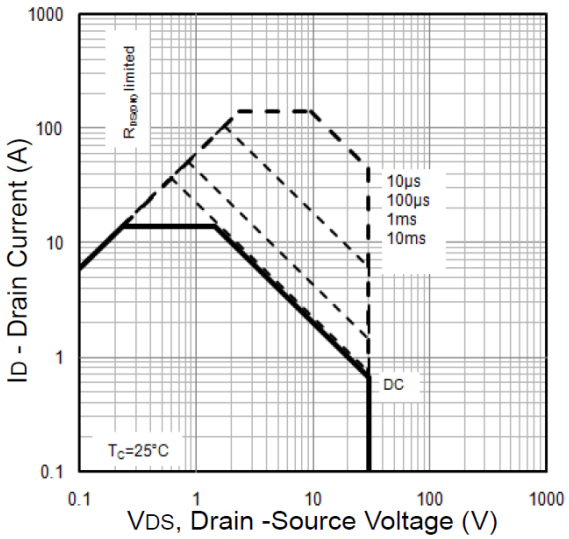


Figure 7: Capacitance vs Vds

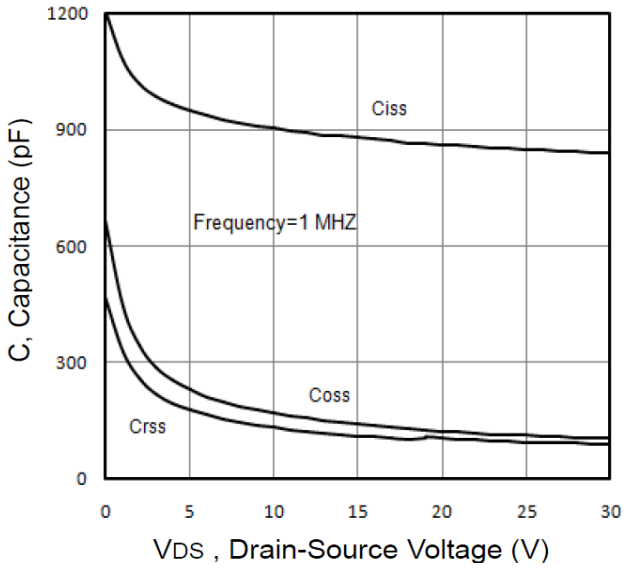


Figure 8: Typical Source-Drain Diode Forward Voltage

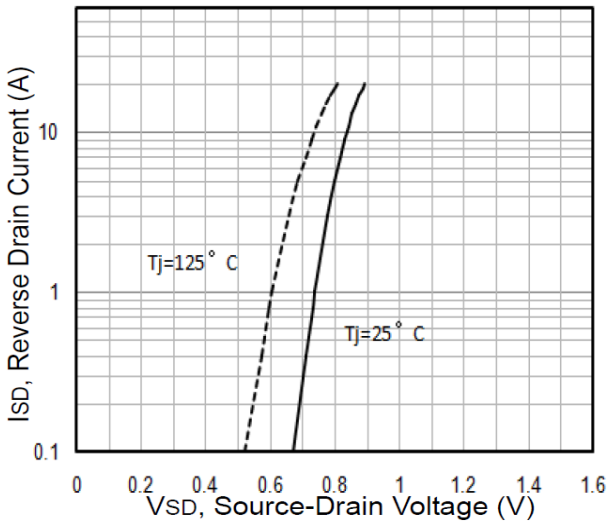


Figure 9: Effective Transient Thermal Response Curve

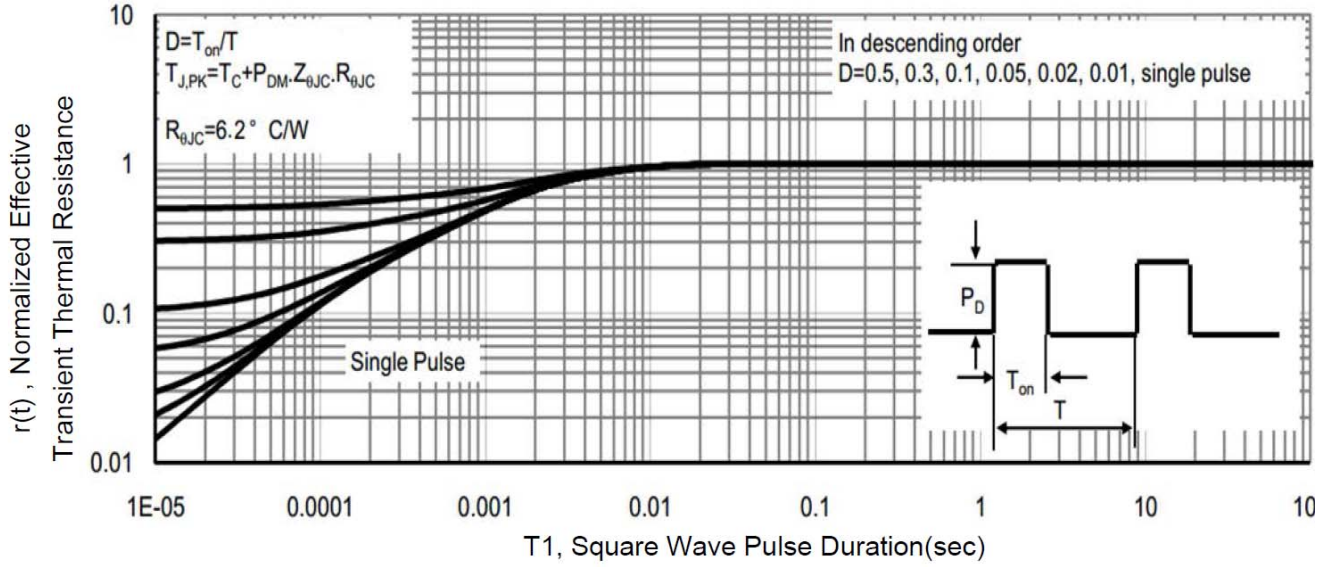


Figure 10: Switching Time Waveform

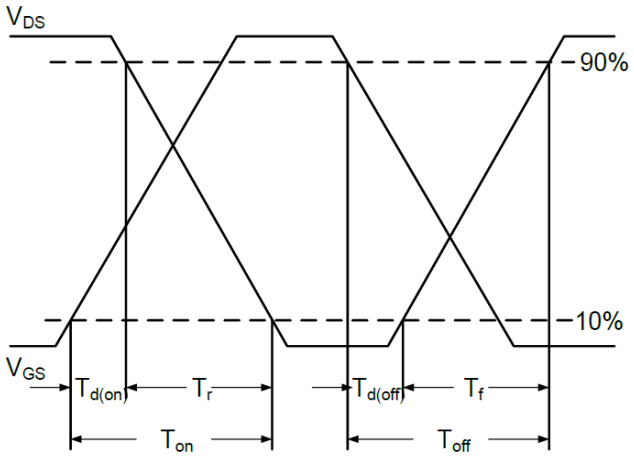
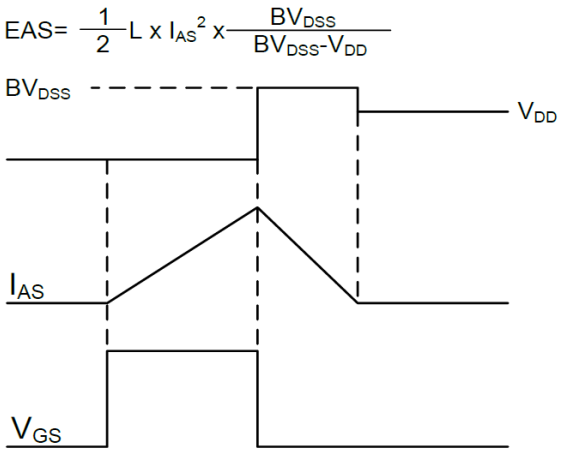
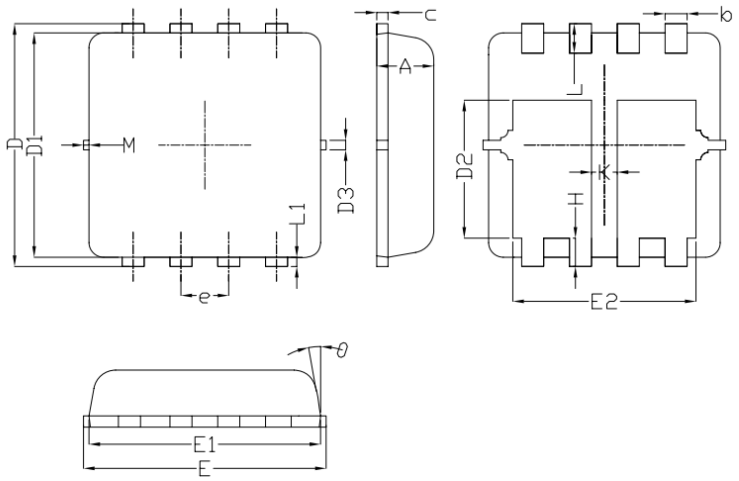


Figure 11: EAS Waveform



PACKAGE MECHANICAL DATA

PDFN（3X3） Package Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.800	0.028	0.031
b	0.250	0.350	0.010	0.013
c	0.100	0.250	0.004	0.009
D	3.250	3.450	0.128	0.135
D1	3.000	3.200	0.119	0.125
D2	1.780	1.980	0.070	0.077
D3	0.130REF		0.005REF	
E	3.200	3.400	0.126	0.133
E1	3.000	3.200	0.119	0.125
E2	2.390	2.590	0.094	0.102
H	0.300	0.500	0.011	0.019
M	0.150REF		0.006REF	
e	0.650 TYP.		0.026 TYP.	
L	0.300	0.500	0.011	0.019
L1	0.130REF		0.005REF	
K	0.300	--	0.011	--
θ	0°	12°	0°	12°

Ordering information

Part number	Package	Marking	Packing	Quantity
ADM35ND03Z	PDFN3*3	M35ND03	Embossed tape	5000pcs

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